

Product Technical Data Sheet

Water PCB cleaner

A water-based remover used for removing solder residues from the surface of packages. Used to clean solder iron frames, stencils and screens. Causes the saponification of rosin and dissolves residual fluxing agent. Its work accelerates in the presence of neutralisers and additives that lower the surface tension. It does not attack metal or aluminium surfaces.

Application:

the preparation should be used in continuous washing lines, periodic chamber devices, washing devices for stencil and transport frame screens of solder assemblies where it is possible to wash packages in water.

Physicochemical properties of the liquid:

Parameters	UoM	Result
Density	g/cm ³	0,98
pH	-	6 - 7
Solubility	-	in water - total
Appearance	-	liquid, colourless

Packagings:

Volume	Type of packaging	Collective packaging	Item Code
1 L	plastic bottle	1	ART.AGT-050
5 L	plastic canister	1	ART.AGT-051

Warehousing:

Store in a well-ventilated, cool and dry place. Protect against sunlight exposure.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.